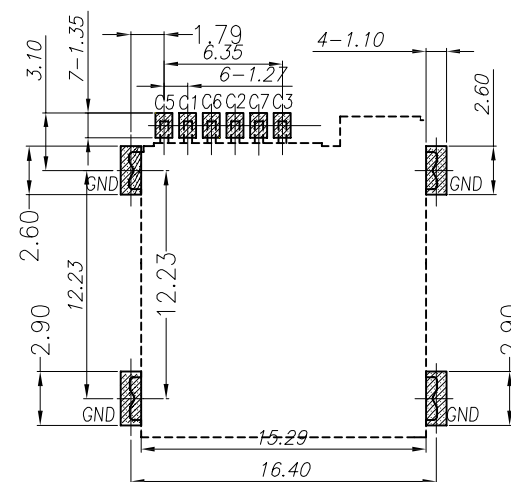
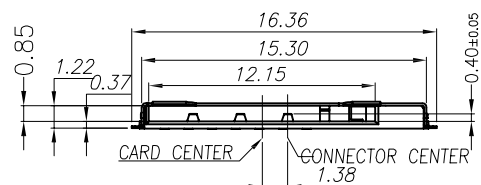
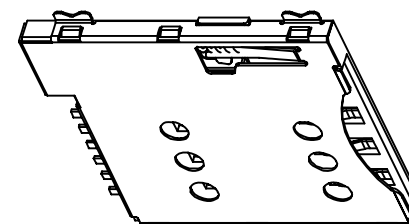
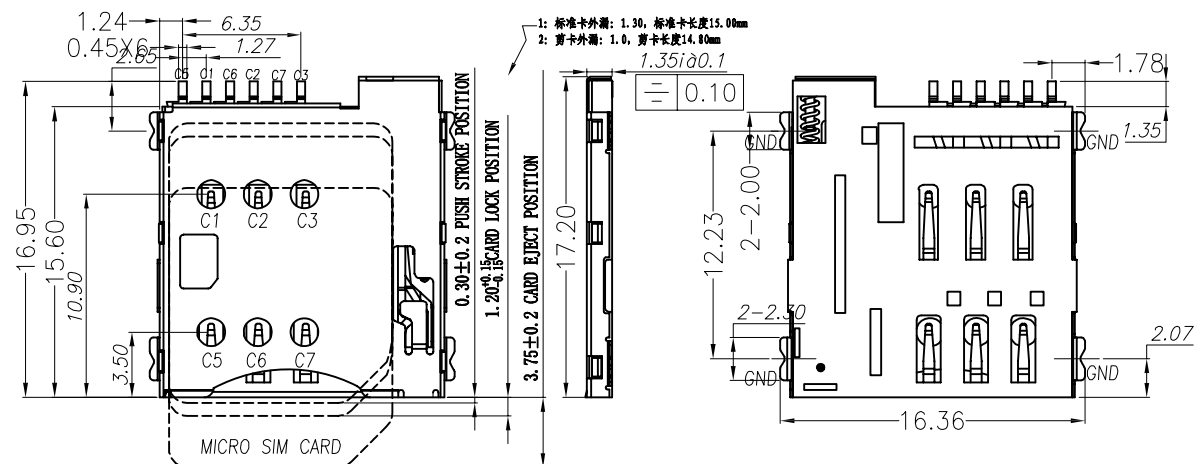


SIM pin assignment	
PIN#	Name
C1	VCC供电电压
C2	RST重置
C3	CLK时钟
C5	GND接地
C6	VPP程序电压
C7	I/O输入输出

Specification

MATERIAL:

Insulator: High Temperature Thermoplastic, UL 94V-0.
Contact: Copper Alloy
SHELL: SUS

PLATING:

Contact: Plated 50u'' Ni Overall Contact Au 1U
Shell: Plated 50u'' Ni Overall
Plated 1u''Au Selective Contact Area

Electrical:

Current Rating : 0.5mA AC/DC max.
Voltage Rating : 125V AC/DC
Ambient Temperature Range : -20° C ~ +60° C
Storage Temperature Range : -40° C ~ +70° C
Ambient Humidity Range : 95% R.H. Max.
Contact Resistance: 100mΩ max. Q
Insulation Resistance: 1000MΩ min./500VDC
产品耐温温度: 260° C $\leq$ 84.70 $\leq$ 84.70 $\leq$ 84.70
Mating Cycles: 3000Min Insertions



RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ± 0.05



深圳市华宇创精密电子有限公司

TOLERANCE:		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME:	
X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X: ±2" X.X ±0.5"				MICRO SIM PUSH 6P 1.35H	
 UNIT: mm [inch]		CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYC13-SIM06-135B
				MOLD NO.	
SCALE:1:1 SIZE: A4		APPROVED BY:	DATE : 2014-02-23	DRAW NO:	HYC-2105241525
				SHEET NO.	1 OF 1